# DR. LEONARD E. SCHNITZER MEMORIAL SCHOLARSHIP FUND

#### Pacific Northwest Chapter ReMA

Four scholarships, each in the amount of \$1,000.00, will be awarded to assist dependents, spouses, and employees of member firms of the Pacific Northwest Chapter of the Recycled Materials Association (ReMA) in pursuing trade school, undergraduate, or graduate education. To be eligible to receive a scholarship an applicant must meet the following requirements:

- 1.) Each applicant must be a dependent of an employee, the spouse of an employee or an employee of an active member firm, in good standing of the Pacific Northwest Chapter of ReMA.
- 2.) Each applicant must intend to pursue studies at an accredited educational institution designed to meet the requirements for an academic, professional, or occupational degree conferred by a college, university, or other accredited school as listed by the U.S, Department of Education at <a href="http://ope.ed.gov/accreditation/Search.aspx">http://ope.ed.gov/accreditation/Search.aspx</a>.
- 3.) Each applicant must meet the minimum admission standards of an educational institution.

The selection of the scholarship recipients will be made by the Scholarship Committee of the Pacific Northwest Chapter of ReMA based solely on objective criteria which include, but are not limited to, prior academic performance, financial need, and a personal history provided as part of the application.

To be considered for a scholarship, please complete the following:

- Attached ReMA 2025 Scholarship Application,
- Application cover letter (personal history summarizing school activities, extracurricular activities, accomplishments, hobbies, personal goals, etc.),
- Short essay (one page or less) on the benefits of recycling, and
- Transcript of grades from the last semester and prior year.

Scholarships may be awarded on a continuing basis, however, the applicant must apply each year for additional scholarship funding. The scholarship shall be awarded for a full year of schooling. Half of the scholarship shall be paid in the first semester, half in the second. Payments will be made directly to the recipient's accredited educational institution, with the assistance of the ReMA finance department.

In the event a recipient does not complete a full year of school, any refunds shall be returned to the Dr. Leonard E. Schnitzer Scholarship Fund, and the recipient shall notify the Scholarship Committee Chairman in writing of any changes in their education as soon as possible.

Please complete all information on the attached forms to expedite review and to facilitate timely funding of scholarships that are awarded through this process. Please submit completed applications by mail and/or email to the following **no later than Friday, June 4, 2025**:

Craig Ware, Chairman of the Scholarship Committee Pacific Northwest Chapter of ReMA 6072 Fernbrook Circle Lake Oswego, Oregon 97035 craigw@centralgeotech.com **Please note:** If your application is received by email, an acknowledgement will be sent in confirmation. If you do not receive a confirmation email, please contact Craig Ware at 503-941-8874 to ensure that your email has not been blocked.

Submissions that are incomplete, unsigned, missing mandatory items, or received after the deadline will be disqualified.

The Pacific Northwest Chapter may issue all, some, or none of the scholarship funds available in any given year. Recipients will be notified in writing of the Chapter's decision by **June 30, 2025**. Further, ReMA and the PNW Chapter are committed to a policy of equal opportunity and will not discriminate against an applicant based on race, color, religion, creed, national origin or ancestry, ethnicity, sex (including, but not limited to gender, sexual orientation, and gender identity), age, physical or mental disability, veteran or military status, genetic information, citizenship, or any other legally recognized protected basis under federal, state, or local law.

The information collected in this application is solely collected to verify identity, determine eligibility, and if selected for a scholarship, for the announcement of scholarship awards, promotion of the scholarship program, or other publication of information related to the scholarship program.

## 2025 Application for Scholarship

(Must be completed by all applicants)

### Dr. Leonard E. Schnitzer Memorial Scholarship Fund ReMA Pacific Northwest Chapter

To: Craig Ware, Chairman of the Pacific Northwest Chapter of ReMA Scholarship Committee. The following is my application for a scholarship established in the name of the Pacific Northwest Chapter of the Recycled Materials Association (ReMA).

### PLEASE PRINT

Name of Chapter:		
Name (legal name only):	Date of Birth:	School ID#
Current Address:		
City:	State:	Zip:
Permanent Address:		
City:	State:	
Email Address:	Telephone Number:	
School Now Attending:		
College or University You Plan to Atten	d:	
Address ( <b>Note:</b> Do not provide general ad	ddress of school, must be directe	d to the Bursar office or building):
Bursar Office Phone Number:		
Do You Plan to Attend Full Term?	Fall Semester Tuition	Due Date:
Major Field of Study You Plan to Pursu	e?	
Any additional information about your Co	ollege or University's scholarshi	p award policy (include):
ReMA PNW Chapter Member Firm:		
Company Address:		
City:		
Length of Employment:	_ Dept. & Job Description	າ:
Is the other parent employed?	-	
If so, where?	Job Description:	

I,	(name of scholarship recipient if recipient is over 18 years old or the name of
the parent of recipien	if the recipient is under 18 years old), do hereby give and grant permission to the
Institute of Scrap Rec	cling Industries, Inc. dba Recycled Materials Association ("ReMA"), and the Pacific
Northwest Chapter of	ReMA, the irrevocable right, permission, and license to publish, reproduce, distribute, and/o
otherwise use: (i) my/	ny child's name; and (ii) any photographic image or likeness of me/my child in conjunction
with the announceme	t of scholarship awards, promotion of the scholarship program, or other publication of
information related to	the scholarship program. I hereby waive all rights of inspection or approval and
compensation with re-	ard to any publication, and/or other use of my/my child's name.
Date:	Signature:
Daic.	Signature.

Release Agreement: